L Number	Hits	Search Text	DB	Time stamp
-	190	156/$.ccls. and press and (heat or heating) and (cool or cooling) and (ID or identification)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/08 19:19
-	25	100/$.ccls. and press and (heat or heating) and (cool or cooling) and (ID or identification)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/08 19:27
-	374	(156/300).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/08 19:35
-	408	(156/303.1).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/10 11:51
-	334	(156/312).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/10 11:54
-	946	((156/583.1) or (156/583.2)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/10 16:47
-	0	"042954"	JPO	2002/07/10 16:47
-	0	"59-042954"	JPO	2002/07/10 16:48
-	0	"002128554"	JPO	2002/07/10 16:48
-	0	"097690"	JPO	2002/07/10 16:48
-	0	"0154104"	JPO	2002/07/10 16:49
-	365811	laminate board produce attach	JPO	2002/07/10 16:49
-	674648	includes attaching thermally insulated plates to edge of hot plates	JPO	2002/07/10 16:50
-	0	"includes attaching thermally insulated plates to edge of hot plates"	JPO	2002/07/10 16:50
-	0	includes and attaching and thermally and insulated and plates and to and edge and of and hot and plates	JPO	2002/07/10 16:51
-	0	(matsushita) and laminate and board and thermal and insulate and plate	JPO	2002/07/10 16:52
-	0	laminate and board and thermal and insulate and plate	JPO	2002/07/10 16:52
-	4	board and thermal and insulate and plate	JPO	2002/07/10 16:53
-	41	board and thermal and laminate and plate	JPO	2002/07/10 16:53
-	870	((156/299) or (156/300)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/10 17:34
-	179	(156/381).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/10 18:08
-	324	((156/559) or (156/563)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/10 18:14

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